

### PTP83012BT24

# SMD Type Phototransistor with Daylight Filter

#### **Features**

- Small double-end package
- High photo sensitivity
- High reliability
- Spectral range of sensitivity: 760-1100nm
- Fast Response time
- RoHS compliance

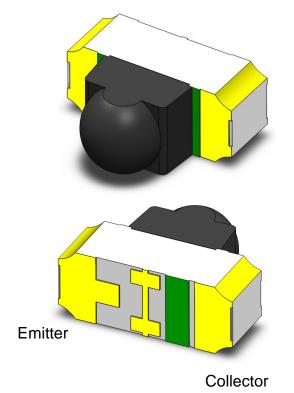
## **Applications**

- Infrared sensor
- Infrared Touch Panel Solutions

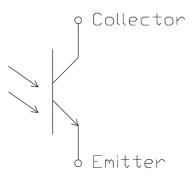
## **Description**

The PTP83012BT24 is silicon NPN Phototransistor housed in a miniature SMD package. The device comes with a superior filtering for visible light by utilizing special black molding compound.

# **Package Outline**



### **Schematic**







# Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
Ic	Collector Current	20	mA	
Bvceo	Collector-Emitter Voltage	35	V	1
B <sub>VECO</sub>	Emitter-Collector Voltage	5	V	2
Topr	Operating Temperature	-40 ~ +85	°C	
T <sub>stg</sub>	Storage Temperature	-40 ~ +100	°C	
T <sub>sol</sub>	Soldering Temperature	260	°C	3
Pto	Total Power Dissipation	150	mW	

## **Optical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
λ	Spectral Bandwidth	-	760	-	1100	nm	
λР	Peak Sensitivity	-	-	880	-	nm	
θ1/2	View Angle	V <sub>CE</sub> =5V	-	±22.5	-	deg	

### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
1	Dark Current	Ee=0mW /cm <sup>2</sup>			100	n 1	
ICEO	Dark Current	V <sub>CE</sub> =20V	-	-	100	nA	
V	Collector-Emitter	Ee=1mW /cm <sup>2</sup>			0.4	V	
V <sub>CE(sat)</sub>	Saturation Voltage	Ic=1.4mA	-	-	0.4	V	
1-	Collector Light Current	Ee=1mW /cm <sup>2</sup>	4.4	2.0		mA	
Ic	Collector Light Current	λρ=940nm, Vce=5V	1.4	2.8	-		
Ст	Tarminal Canacitanas	Ee=0mW /cm <sup>2</sup>		2.00		,r	
	Terminal Capacitance	f=1MHz ,V <sub>CE</sub> =5V	-	3.80	_	pF	

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## **Switching Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
tr	Rise Time		-	6	-		
t <sub>f</sub>	Fall Time	$V_{ce} = 5V$ , $R_L = 100\Omega$	-	7	-		4
ton	Turn on Delay Time	Ic=1.0mA	-	11	-	μs	4
t <sub>off</sub>	Turn off Delay Time		-	7.9	-		

#### Notes:

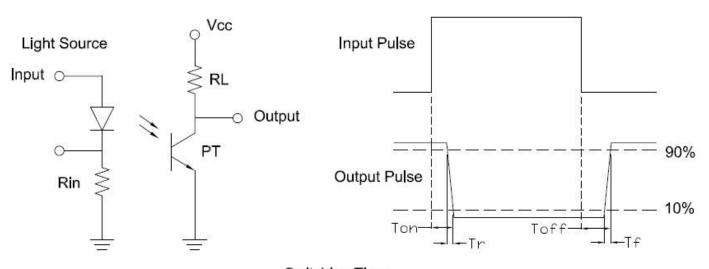
1 : Test conditions :  $I_C=100\mu A$ ,  $Ee=0mW/cm^2$ .

2: Test conditions: I<sub>E</sub>=100µA, Ee=0mW/cm<sup>2</sup>.

3 : Soldering time  $\leq$  5 seconds.

4 : Test circuit:

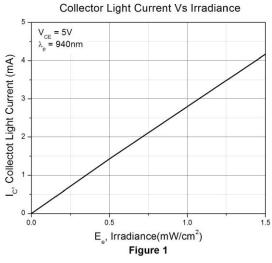
#### Detector

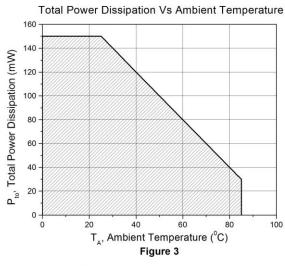


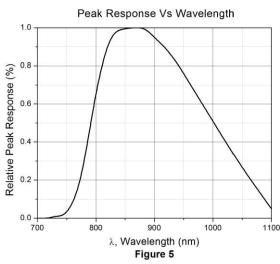


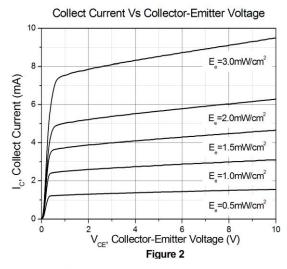


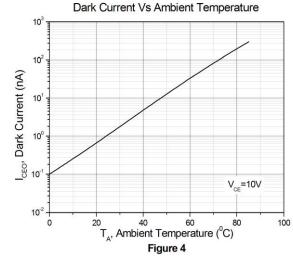
## **Typical Characteristic Curves**

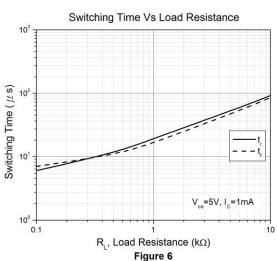






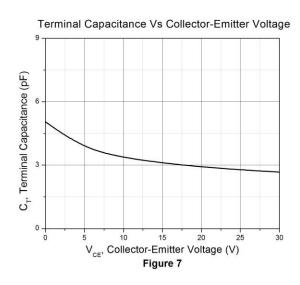




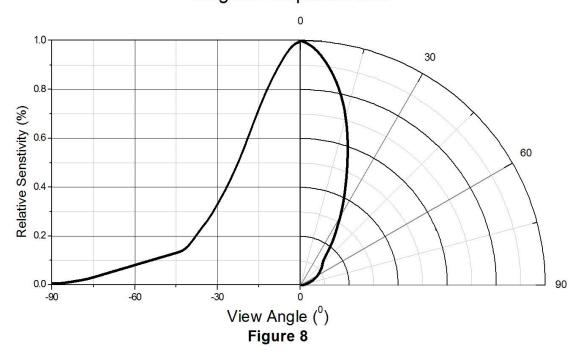




# **Typical Characteristic Curves**

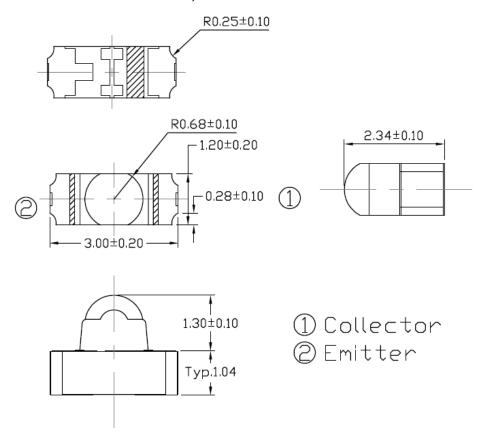


## **Angular Displacement**

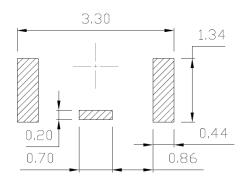




# Package Dimension All dimensions are in mm, unless otherwise stated



## Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



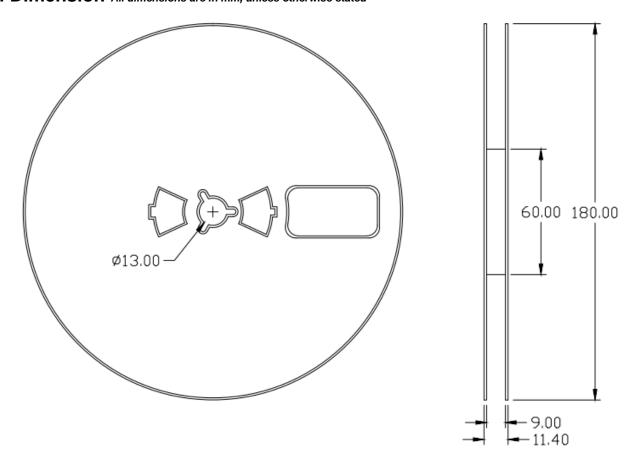
# **Ordering Information**

Part Number	Description	Quantity
PTP83012BT24	Tape & Reel	2000 pcs

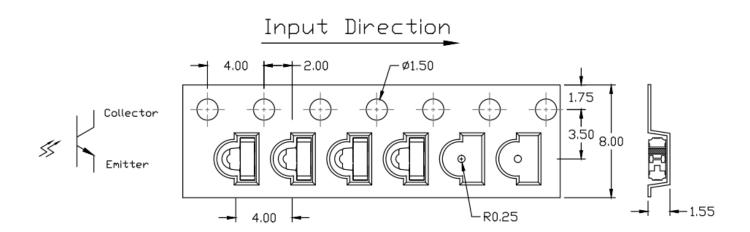




## Reel Dimension All dimensions are in mm, unless otherwise stated



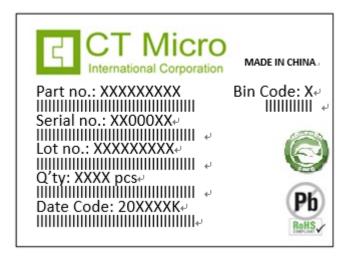
Tape Dimension All dimensions are in mm, unless otherwise stated







### **Label Form Specification**



Part no: CTM Production Number Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

Bin Code: Ic Ranks

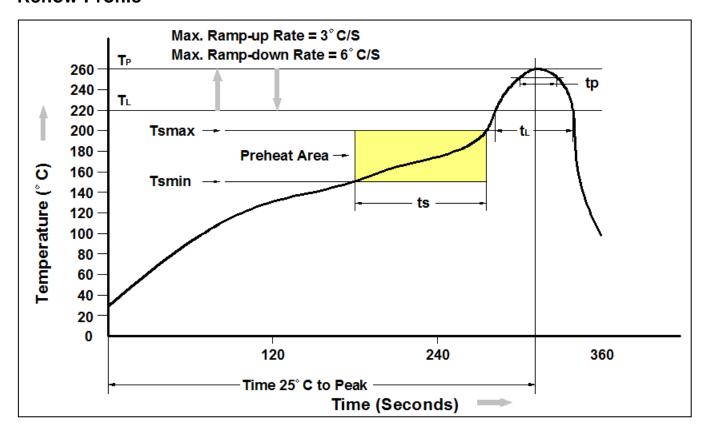
MADE IN CHINA: Production Place

### **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



## **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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